

PRODUCT NUMBER
75189-YYY-XXLF

RoHS COMPLIANT & COMPATIBLE, SEE NOTE 7

NUMBER OF CONTACTS, 2 TO 18.

PIN STYLE

PLATING:

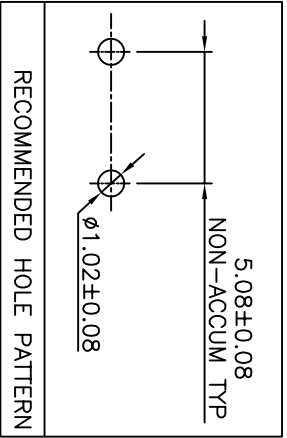
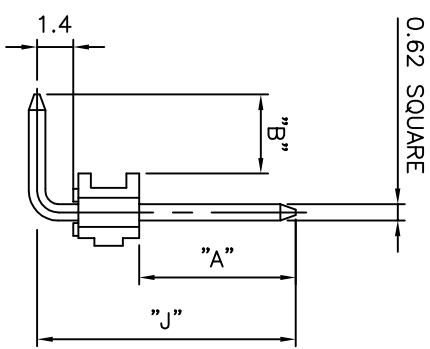
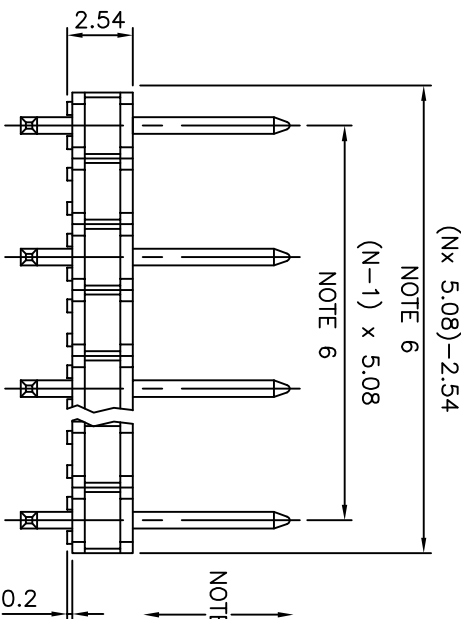
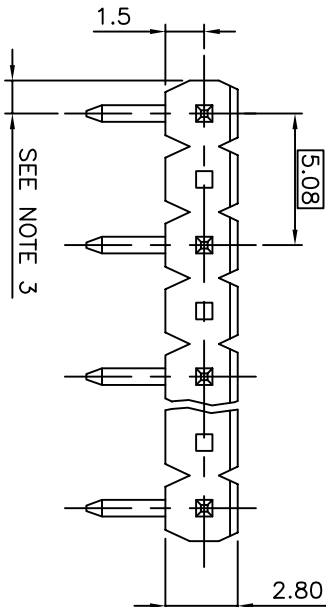
1 = 0.76µm FULL GOLD

1.27µm Ni MIN UNDERPLATING

NOTES:

1. HOUSING MAT'L : HIGH TEMPERATURE THERMOPLASTIC FLAME RETARDANT PER UL94-V0, COLOR BLACK.
2. PIN MATERIAL : PHOSPHOR BRONZE.
3. DIM 1.27^{+0.03}_{-0.13} FOR MOULDED SIDE(S) ONLY. IF SIDE(S) ARE BROKEN, DIM 1.02 TO 1.7 MAX APPLIES.
4. PIN PUSH OUT FORCE : 12N MIN.
5. PRODUCT PACKAGED IN POLY BAGS.
6. TO DETERMINE DIMENSIONS :
N = NUMBER OF CONTACTS
7. RoHS COMPATIBLE PRODUCT SPECIFICATIONS
 - a - LF MEANS THE PRODUCT IS LEAD-FREE
 - b - MANUFACTURING PROCESS COMPATIBILITY
 - THE HOUSING WILL WITHSTAND EXPOSURE TO 260°C ±5°C SOLDER BATH TEMPERATURE FOR 5 SECONDS IN A WAVE SOLDER APPLICATION WITH A 1.6mm MIN THICK CIRCUIT BOARD.
 - MEETS PACKAGING SPECS AS PER GS-14-920
 - c - LABELING:
 - d - LEGAL STATEMENT: SEE GS-47-0004

STYLE	"A"±0.2	"B"±0.35	"J" REF
01	5.72	2.57	9.65
13	5.72	3.45	9.65



mat'l. code				surface			tolerance			projection		product family	
ltr	ecn no	dr	date	ISO 1302	ISO 406	ISO 1101	tolerances unless otherwise specified	ISO 406	ISO 1101	mm	mm	title	BSTIK
H	F10076	JMC	91.02.25	angles			X ±0.3					HEADER,SR,RA,	
J	F05-0184	JCO	05.06.09	linear	xx ±0.15							POL 5.08mm	
K	F06-0198	LMU	06.06.20	xxx ±0.05								scale 5:1	
L	B-19261	LMU	14.10.31	dr	LMU		05.06.09					dwg no	sheet 1 of 1
				engr	J.COMPAIGNON		05.06.09					size	
				chr								A3	
				appd	JCO		05.06.09					type	CUSTOMER
												Drawing	
sheet	revision												
index	sheet												